## **3M** Circuit Plating Tape 1280

or typi nesion to S sile Streng	i <b>cal only and should</b> teel: th (Break or Yield): reak or Yield): ness:	formation and I not be used for 31 oz./in. width	r specification purj n (33.9 N/100 mm) h (525.4 N/100 mm) nm)	ASTM Test Method D-3330
te: The foi or typi nesion to S sile Streng ngation (Br king Thick	<b>Ilowing technical in</b> i <b>cal only and should</b> teel: th (Break or Yield): reak or Yield): ness:	formation and I not be used for 31 oz./in. width 30 lbs./in. widt 135% 0.9 mil (0.02 m	data should be con r specification purj n (33.9 N/100 mm) h (525.4 N/100 mm) nm)	144 yds. (132 m) sidered representative poses. ASTM Test Method D-3330 ) D-3759 D-3759 D-3759 D-3652
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ngation (Br king Thick	reak or Yield): ness:	135% 0.9 mil (0.02 m	ım)	D-3759 D-3652
king Thick	ness:	0.9 mil (0.02 m		D-3652
•		-		
al Tape Thi	ckness:	3.6 mils (0.091	mm)	D-3652
	ch polyester film fo			
<ul> <li>Solvent clean up of the board is recommended to facilitate subsequent soldering.</li> <li>Polyester backing reduces stretch and recovery of tape and associated uneven stop-off line.</li> </ul>				
	Ũ	ces undercuttir	ng because adhesi	ve helps block out
• Must be firmly pressed down by equipment with rubber-covered rollers. Hand rolling usually does not provide enough pressure. A vivid outline of the circuit leads usually indicates that adequate pressure was used.				
lape gene	rally performs bett	ter when no ov	ens are used to he	eat tape and boards.
<ul> <li>Masking of many printed wiring boards during solder stripping and precious metal plating of fingers.</li> </ul>				
	Must be fi olling usu eads usua Fape gene Masking o netal plat	Must be firmly pressed down olling usually does not prove eads usually indicates that a Fape generally performs bet Masking of many printed win netal plating of fingers.	Must be firmly pressed down by equipmen olling usually does not provide enough pre eads usually indicates that adequate pressu fape generally performs better when no ov	Must be firmly pressed down by equipment with rubber-cov olling usually does not provide enough pressure. A vivid ou eads usually indicates that adequate pressure was used. Fape generally performs better when no ovens are used to he Masking of many printed wiring boards during solder stripp netal plating of fingers.

## **3M<sup>™</sup> Circuit Plating Tape** 1280

Store under normal conditions of  $60^{\circ}$  to  $80^{\circ}$ F ( $16^{\circ}$  to  $27^{\circ}$ C) and 50% R.H. in the Storage original carton. Shelf Life To obtain best performance, use this product within 18 months from date of manufacture. Product Use All statements, technical information and recommendations contained in this document are based upon tests or experience that 3M believes are reliable. However, many factors beyond 3M's control can affect the use and performance of a 3M product in a particular application, including the conditions under which the product is used and the time and environmental conditions in which the product is expected to perform. Since these factors are uniquely within the user's knowledge and control, it is essential that the user evaluate the 3M product to determine whether it is fit for a particular purpose and suitable for the user's method of application. Warranty and Unless stated otherwise in 3M's product literature, packaging inserts or product packaging for individual products, 3M warrants that each 3M product meets the applicable specifications at the time 3M ships the Limited Remedy product. Individual products may have additional or different warranties as stated on product literature, package inserts or product packages. 3M MAKES NO OTHER WARRANTIES, EXPRESS OR IMPLIED, INCLUDING, BUT NOT LIMITED TO, ANY IMPLIED WARRANTY OF MERCHANTABILITY OR FITNESS FOR A PARTICULAR PURPOSE OR ANY IMPLIED WARRANTY ARISING OUT OF A COURSE OF DEALING, CUSTOM OR USAGE OF TRADE. User is responsible for determining whether the 3M product is fit for a particular purpose and suitable for user's application. If the 3M product is defective within the warranty period, your exclusive remedy and 3M's and seller's sole obligation will be, at 3M's option, to replace the product or refund the purchase price. Except where prohibited by law, 3M and seller will not be liable for any loss or damage arising from the Limitation of Liability 3M product, whether direct, indirect, special, incidental or consequential, regardless of the legal theory asserted, including warranty, contract, negligence or strict liability. ISO 9001:2000 This Industrial Adhesives and Tapes Division product was manufactured under a 3M quality system registered to ISO 9001:2000 standards.



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